## **CPC1301**

Fastwel

## COM Express Module based on Intel® Core® 2 Duo CPU



# Intel<sup>®</sup> Core<sup>®</sup> 2 Duo/Core Duo/Celeron CPUs with 533/667 MHz FSB COM Express Type II pinout Up to 4 GB DDR2 dual channel memory

- CRT and LVDS
- **5** x1 or 1 x4 and 1 x1 PCI-Express
- x16 PCI Express graphics interface
- Gigabit Ethernet port
- I2c bus
- Eight USB 2.0 ports
- Two Serial ATA, one IDE Ultra ATA/100 interface
- Extended temperature range

## Best solutions to fit your demands!

#### **CPC1301** COM Express module based on Intel® Core® 2 Duo CPU



#### **Features**

- Intel® Core® 2 Duo/Core Duo/Celeron CPUs with 533/667 MHz FSB
- COM Express Type II pinout
- Up to 4 GB DDR2 dual channel memory
- CRT and LVDS
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#### **Overview**

CPC1301 is a COM Express Module based on Intel® Core® 2 Duo/Core Duo/Celeron CPUs up to 2.16 GHz with 533/667 MHz front side bus and Intel chipset comprising 945GM GMCH and ICH7M. Memory interface supports dual DDR2 SDRAM through two SODIMM sockets with total capacity of up to 4 GB.

Multimedia functions are supported by interfaces for CRT-monitor, flat panels with dual LVDS interface and AC'97 audio codec. External graphic adapters can be connected through x16 PCI Express interface.

Gigabit Ethernet channel makes this board perfect for developing communication intensive applications.

Peripheral devices can be connected to CPC1301 through PCI Express interfaces, 8 high-speed USB 2.0 ports, LPC, AC'97.

CPC1301 storage subsystem supports two SATA and one IDE Ultra ATA/100 disk drives.

CPC1301 supports Suspend-to-RAM mode.

For performance evaluation and application stack development, Fastwel provides development board — KIB1280, which gives access to all features of CPC1301 and facilitates software and hardware design.

Additional reliability of CPC1301 is provided by hardware monitoring, watchdog timer, reserved CMOS memory and a set of system monitoring features.

CPC1301 operates in industrial ( $-40^{\circ}$ C to +85°C) and commercial (0°C to +70°C) temperature ranges.

#### **Technical Specifications**

- System
- CPUs:
- Intel® Core® 2 Duo processor 2.16 GHz, 4 MB cache L2, 667 MHz FSB
- Intel<sup>®</sup> Core<sup>®</sup> 2 Duo processor 1.5 GHz 4 MB cache L2, 667 MHz FSB
- $\bullet$  Intel® Core® Duo processor 1.66 GHz 2 MB cache L2, 667 MHz FSB
- Intel® Celeron® M 423 processor 1.06 GHz, 2 MB cache L2, 533 MHz FSB
- Chipset: 945GM GMCH & ICH7M
- Up to 4 GB DDR2 SDRAM, two SODIMM sockets
- CPU temperature and voltage control sensors
- Reserved CMOS memory
- MTBF: 140 000 hours

#### BIOS

Phoenix® BIOS with

- LAN Boot
- USB Boot
- Multi Boot
- Quick Boot

#### Graphics

- Video controller integrated into 945GM
- Video memory up to 64 MB shared with system
- Analog display interface supports resolutions up to 2048×1536 @ 75 Hz
- Dual LVDS
- TV-Out

#### **Storage**

- One IDE Ultra ATA/100 interface connector
- Two Serial ATA interfaces

#### Software support

- Fastwel DOS™ (MS™ DOS compatible)
- Windows XP Embedded
- Linux® 2.6
- QNX 4.2, 6.0

#### I/O Interfaces & Expansion

- One Gigabit Ethernet port 10/100/1000 Mb/s
- One x16 PCI Express interface

- 5 x1 PCI-Express, also configurable as 1 x1 and 1 x4
- 32-bit PCI interface
- AC'97 interface
- LPC interface
- Express Card interface support
- Eight USB 2.0 ports

#### **Mechanical**

- Dimensions: 95×125 mm (3.74"×4.92")
- Weight: 0.15 kg

#### **Power requirements**

• +12 V @ 4 A and +5 V @ 1 A

#### **Environmental conditions**

- Operating temperature: \_40°C to +85°C — industrial
- 0°C to +70°C commercial • Storage temperature: -50°C to +95°C
- Humidity: 95% noncondensing
- Shock/Vibration: 50G/2G
- Cooling system: heat spreader and radiator

#### Compliancy

• PICMG COM.0. COM Express Module Base Specification Rev. 1.0. Pin-out type II

#### **List of Deliverables**

- CPC1301 Module
- Screws set
- $\bullet$  Cooling system for CPU and GMCH hub
- CD with drivers and documentation

#### Warranty

· 3 years for parts and labor



CPC1301 with radiator and fan

#### **Board Layout**



#### **KIB1280**

ATX form-factor compaliant carrier board for ComExpress/ComExpress Extended Type II pinout modules.

#### Interfaces

- VGA, S-Video, LVDS
- 1×GbEthernet 10/100/1000-Base-T RJ45
- 1×16 PCI Express, 3×1 PCI Express, 3×PCI
- 6×USB2.0
- IDE UltraATA, 4×SATA, CF Type I/II socket with IDE interface
- 2×COM232, LPT, FDD, PS/2
- 2×Express<sup>™</sup> Card slots
- Audio line-in/out, MIC
- LPC interface, SMBUS, PLCC, fan connector, control&signalling interfaces and LEDs, ATX power supply.

Please read User manual for complete product description.



\*Four  $\times$ 1 PCI-Express channels can be integrated into one  $\times$ 4 channel

### **Ordering Information**

#### **CPC1301** Configuration

#### CPC1301 - 01 - C2D1.5 - I \Options

1		
	Device Type	
	CPC1301	CPC1301 COM Express Intel <sup>®</sup> Core <sup>®</sup> Module, Intel <sup>®</sup> 945GM chipset, DDR2 SODIMM, Gigabit Ethernet, LVDS, PCI-Express, 8 USB, 2 SATA
	Processor	
١	CD1.66	Intel <sup>®</sup> Core Duo 1.66 GHz LV
	CS1.06 C2D1 5	Intel <sup>®</sup> Celeron M 423 1.06 GHz
	C2D2.16	Intel <sup>®</sup> Core 2 Duo 2.16 GHz
SODIMM Memory Module		odule
١	SC-SODIMM-DDR2-1024	1024 MB, Single channel
	DC-SODIMM-DDR2-2048	2048 MB. Dual channel
		(C - commercial, I - industrial)
	DC-SODIMM-DDR2-4096	4096 MB, Dual channel (C - commercial L - industrial)
	Tomnoraturo Rango	
ζ		
	C	Commercial Range, -40+85°C
	Ontions	,
9	\xxx	Choose available options from the table
- 1		

Coating		
\COATED	Protective Coating	
Radiator		
\R3	Ribbed radiator, no fan, lengthwise orientation OSX77	
\R3F	Ribbed radiator, fan, lengthwise orientation OSX77	
\R4	Ribbed radiator, no fan, widthwise orientation OSX77	
\R4F	Ribbed radiator, fan, widthwise orientation OSX77	
Heatspreader, heatsink and fan (preliminary information):		
\R	Heatspreader (with CS1.06 only)	
\R3	Ribbed heatsink, no fan, ribs oriented lengthwise, OSX77	
\R3F	Ribbed heatsink, with fan, ribs oriented lengthwise, OSX77	
\R4	Ribbed heatsink, no fan, ribs oriented widthwise, OSX77	
\R4F	Ribbed heatsink, with fan, ribs oriented widthwise, OSX77	
\R5	Ribbed heatsink, no fan, ribs oriented lengthwise, OSX98	
\R5F	Ribbed heatsink, with fan, ribs oriented lengthwise, OSX98	
\R6	Ribbed heatsink, no fan, ribs oriented widthwise, OSX98	
\R6F	Ribbed heatsink, with fan, ribs oriented widthwise, OSX98	

**CPC1301 Available Options** 

Other configurations and options are available upon request.

#### **Example**

#### CPC1301-01-C2D1.5- DC-SODIMM-DDR2-4096-I\COATED\R3F

CPC1301 COM Express Intel® Core® 2 Duo Module, Intel® 945GM chipset, DDR2 SODIMM, Gigabit Ethernet, LVDS, 5 ×1 PCI-Express, 8 USB, 2 SATA Intel<sup>®</sup> Core 2 Duo 1.5 GHz 4096 MB DDR2 SDRAM in SODIMM sockets, Dual channel, Industrial Protective coating Ribbed heatsink, with fan, ribs oriented lengthwise, OSX77

#### Ver. 1.4 2011 Product specifications are subject to change without notice

#### **Applications**



Mobile



Communications



Industrial Automation



Embedded

PCI

**EXPRESS** 



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